

Special Issue

Micro and Nano-Manufacturing

Message from the Guest Editor

Micro- and nano-scale manufacturing is gaining more attention due to production miniaturization and customization. High precision and product quality are difficult to achieve at this length scale; thus, a deeper understanding of the processes, development of characterization methods, modeling and simulations, and monitoring are required for the improvement of product quality and mass scale productivity. This Special Issue of *JMMP* will focus on advances in micro- and nano-scale manufacturing processes and systems that address the aforementioned requirements. Both theoretical and experimental contributions are welcome. Application-oriented novel manufacturing processes and systems are also of interest.

Guest Editor

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About the Journal

Message from the Editor-in-Chief

Journal of Manufacturing and Materials Processing (JMMP) (ISSN 2504-4494) is a new MDPI peer-reviewed, open access venue with a focus on the scientific fundamentals and engineering methodologies of manufacturing and materials processing. We offer an online platform facilitating effective exchange of innovative scientific and engineering ideas and the dissemination of recent, original, and significant research and developmental findings. On behalf of the Editorial Board, I extend an invitation to our scientific and engineering colleagues to contribute high-quality, innovative, and ground-breaking research articles to *JMMP*.

Editor-in-Chief

Prof. Dr. Steven Y. Liang
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